



# PNE20030EP

200 V, 3 A hyperfast recovery rectifier

10 January 2024

Product data sheet

## 1. General description

High power density, hyperfast recovery rectifier with high-efficiency planar technology, encapsulated in a small and flat lead CFP5 (SOD128) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Reverse voltage  $V_R \leq 200$  V
- Forward current  $I_F \leq 3$  A
- Switching time  $t_{rr} \leq 30$  ns
- Pt doped life time control
- Low inductance
- Small and flat lead SMD plastic package
- Package height typ. 1 mm
- High power capability due to clip-bond technology
- Planar die design
- Capable for reflow and wave soldering

## 3. Applications

- General-purpose rectification
- Reverse polarity protection
- Hyperfast switching
- Freewheeling applications

## 4. Quick reference data

Table 1. Quick reference data

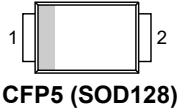
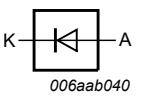
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 155$ °C		-	-	3	A
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25$ °C		-	-	200	V
$V_R$	reverse voltage			-	-	200	V
$V_F$	forward voltage	$I_F = 3$ A; $T_j = 25$ °C	[1]	-	875	980	mV
		$I_F = 3$ A; $T_j = 125$ °C	[1]	-	730	820	mV
$I_R$	reverse current	$V_R = 200$ V; $T_j = 25$ °C	[1]	-	-	1	µA
		$V_R = 200$ V; $T_j = 125$ °C	[1]	-	1.5	35	µA

[1] Very short pulse, in order to maintain a stable junction temperature.

**nexperia**

## 5. Pinning information

**Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	A	anode		

## 6. Ordering information

**Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
PNE20030EP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	<a href="#">SOD128</a>

## 7. Marking

**Table 4. Marking codes**

Type number	Marking code
PNE20030EP	DG

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 601134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25^\circ\text{C}$		-	200	V
$V_R$	reverse voltage			-	200	V
$V_{RMS}$	RMS voltage			-	140	V
$I_F$	forward current	$\delta = 1$ ; $T_{sp} \leq 150^\circ\text{C}$		-	4.2	A
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20\text{ kHz}$ ; square wave; $T_{sp} \leq 155^\circ\text{C}$		-	3	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8.3\text{ ms}$ ; single half sine wave (applied at rated load condition); $T_{j(\text{init})} = 25^\circ\text{C}$		-	75	A
$P_{\text{tot}}$	total power dissipation	$T_{\text{amb}} \leq 25^\circ\text{C}$	[1]	-	0.81	W
			[2]	-	1.3	W
$T_j$	junction temperature			-	175	°C
$T_{\text{amb}}$	ambient temperature			-55	175	°C
$T_{\text{stg}}$	storage temperature			-65	175	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

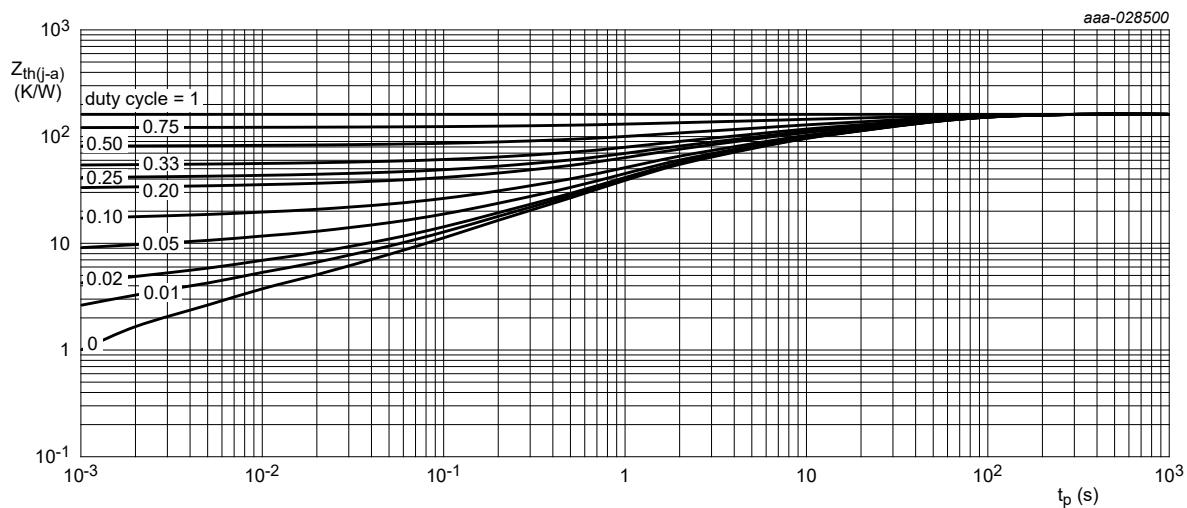
**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	[1]	-	-	185	K/W
			[2]	-	-	115	K/W
$R_{\text{th(j-sp)}}$	thermal resistance from junction to solder point		[3]	-	-	8	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

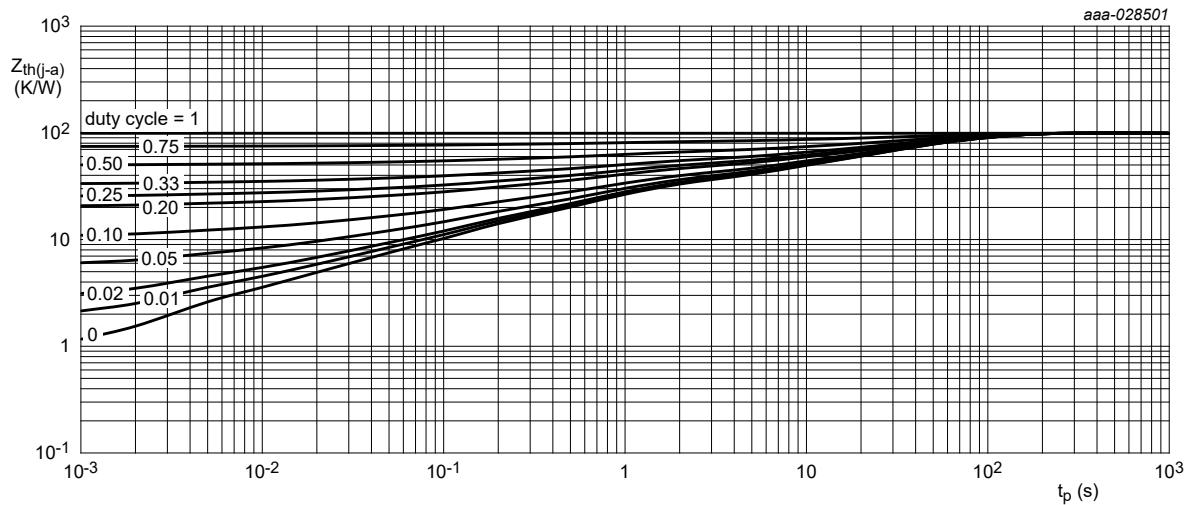
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

[3] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode  $1 \text{ cm}^2$

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 100 \mu A; T_j = 25^\circ C$	[1]	200	-	-	V
$V_F$	forward voltage	$I_F = 3 A; T_j = 25^\circ C$	[1]	-	875	980	mV
		$I_F = 3 A; T_j = 125^\circ C$	[1]	-	730	820	mV
$I_R$	reverse current	$V_R = 200 V; T_j = 25^\circ C$	[1]	-	-	1	$\mu A$
		$V_R = 200 V; T_j = 125^\circ C$	[1]	-	1.5	35	$\mu A$
$C_d$	diode capacitance	$V_R = 4 V; f = 1 MHz; T_j = 25^\circ C$		-	32	-	pF
$t_{rr}$	reverse recovery time ; step recovery	$I_F = 0.5 A; I_R = 1 A; I_{R(meas)} = 0.25 A; T_j = 25^\circ C$		-	13	30	ns
	reverse recovery time ; ramp recovery	$I_F = 1 A; dI_F/dt = 50 A/\mu s; V_R = 30 V; T_j = 25^\circ C$		-	22	-	ns
		$I_F = 1 A; dI_F/dt = 100 A/\mu s; V_R = 30 V; T_j = 25^\circ C$		-	17	-	ns
$I_{RM}$	peak reverse recovery current			-	1	-	A
$Q_{rr}$	reverse recovery charge			-	16	-	nC
$V_{FRM}$	peak forward recovery voltage	$I_F = 1 A; dI_F/dt = 50 A/\mu s; T_j = 25^\circ C$		-	820	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.

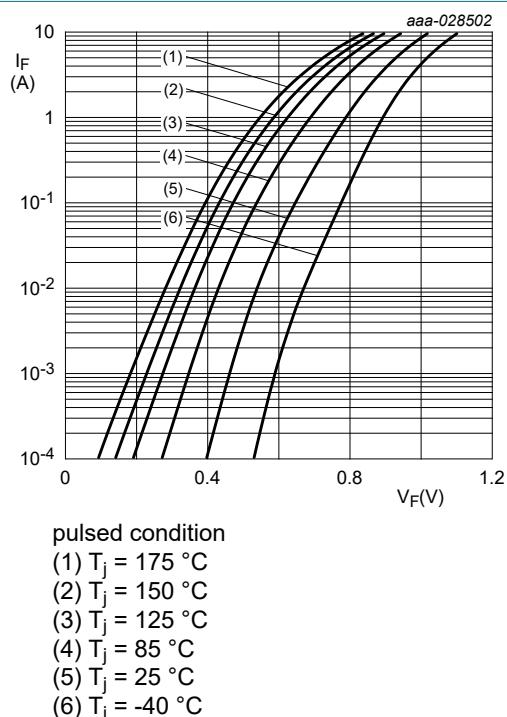


Fig. 3. Forward current as a function of forward voltage; typical values

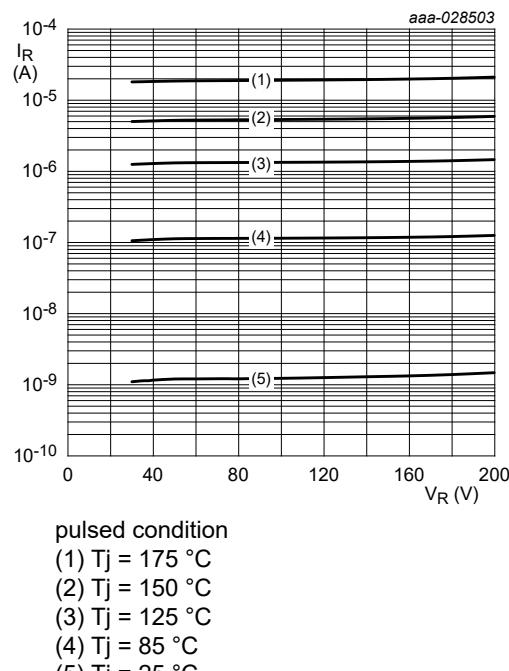
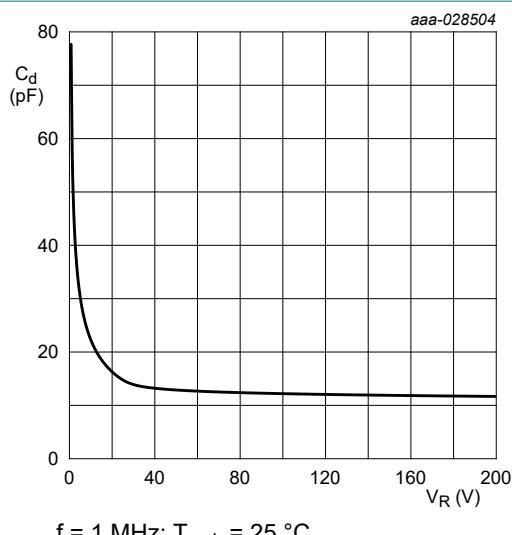
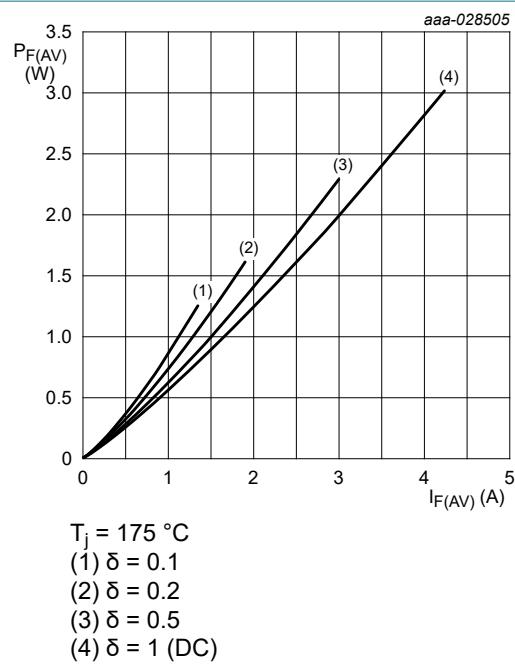


Fig. 4. Reverse current as a function of reverse voltage; typical values

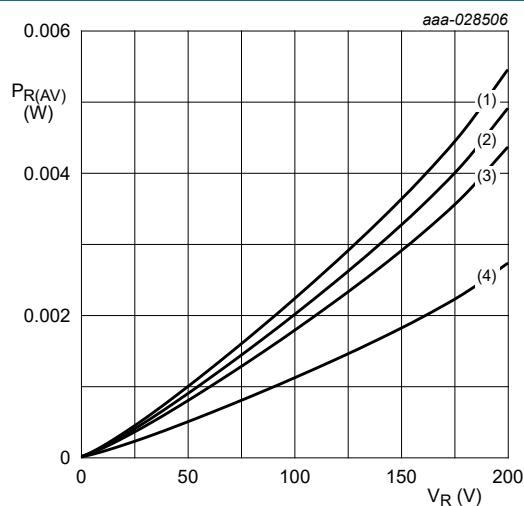


$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$

**Fig. 5. Diode capacitance as a function of reverse voltage; typical values**

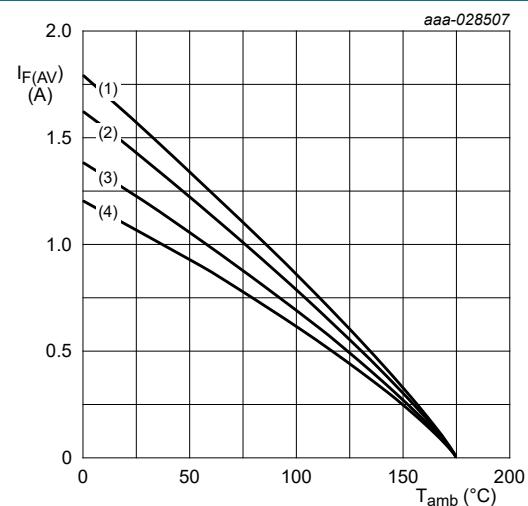


**Fig. 6. Average forward power dissipation as a function of average forward current; typical values**



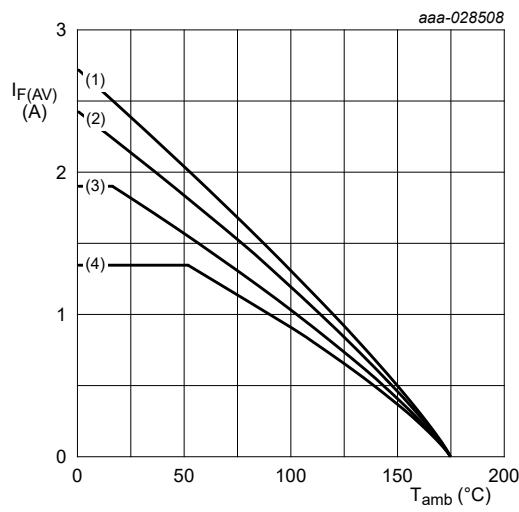
$T_j = 175 \text{ }^{\circ}\text{C}$   
 (1)  $\delta = 1; \text{DC}$   
 (2)  $\delta = 0.9$   
 (3)  $\delta = 0.8$   
 (4)  $\delta = 0.5$

**Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values**



FR4 PCB, standard footprint  
 $T_j = 175 \text{ }^{\circ}\text{C}$   
 (1)  $\delta = 1; \text{DC}$   
 (2)  $\delta = 0.5; f = 20 \text{ kHz}$   
 (3)  $\delta = 0.2; f = 20 \text{ kHz}$   
 (4)  $\delta = 0.1; f = 20 \text{ kHz}$

**Fig. 8. Average forward current as a function of ambient temperature; typical values**



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

$T_j = 175$  °C

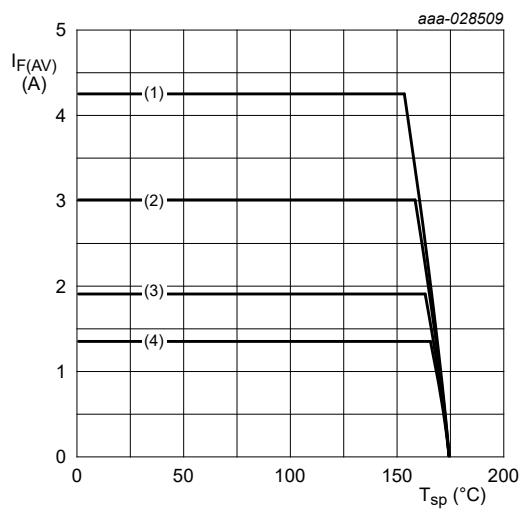
(1)  $\delta = 1$ ; DC

(2)  $\delta = 0.5$ ;  $f = 20$  kHz

(3)  $\delta = 0.2$ ;  $f = 20$  kHz

(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



$T_j = 175$  °C

(1)  $\delta = 1$ ; DC

(2)  $\delta = 0.5$ ;  $f = 20$  kHz

(3)  $\delta = 0.2$ ;  $f = 20$  kHz

(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

## 11. Test information

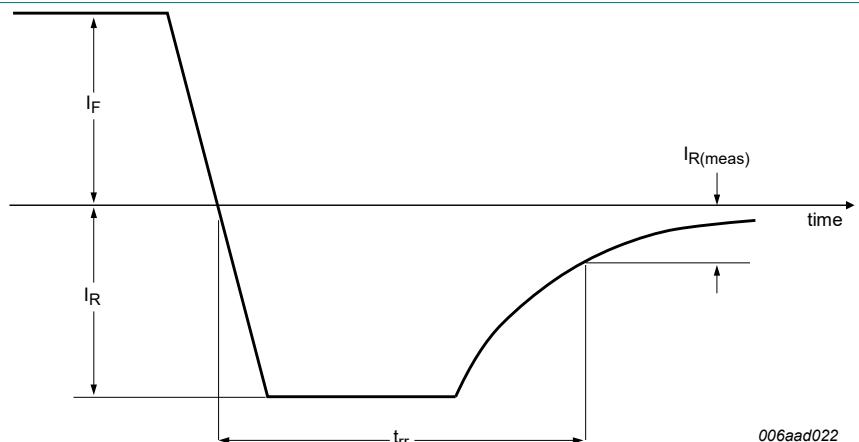


Fig. 11. Reverse recovery definition; step recovery

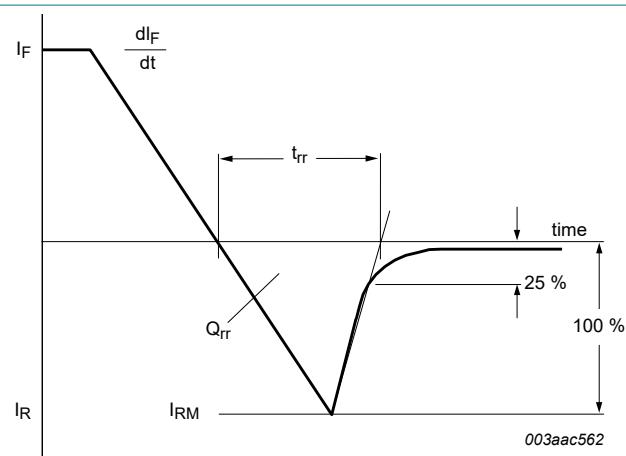


Fig. 12. Reverse recovery definition; ramp recovery

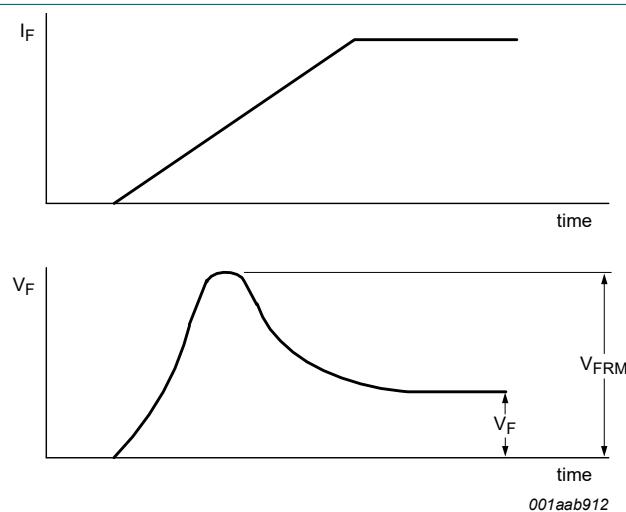


Fig. 13. Forward recovery definition

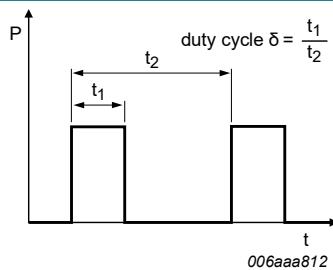


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC, and } I_{RMS} = I_M \times \sqrt{\delta}$$

with  $I_{RMS}$  defined as RMS current.

## 12. Package outline

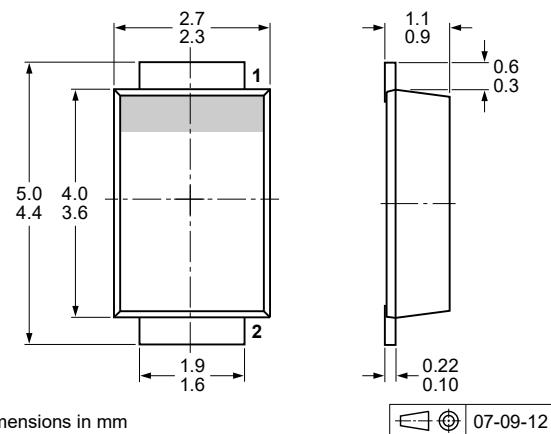


Fig. 15. Package outline CFP5 (SOD128)

## 13. Soldering

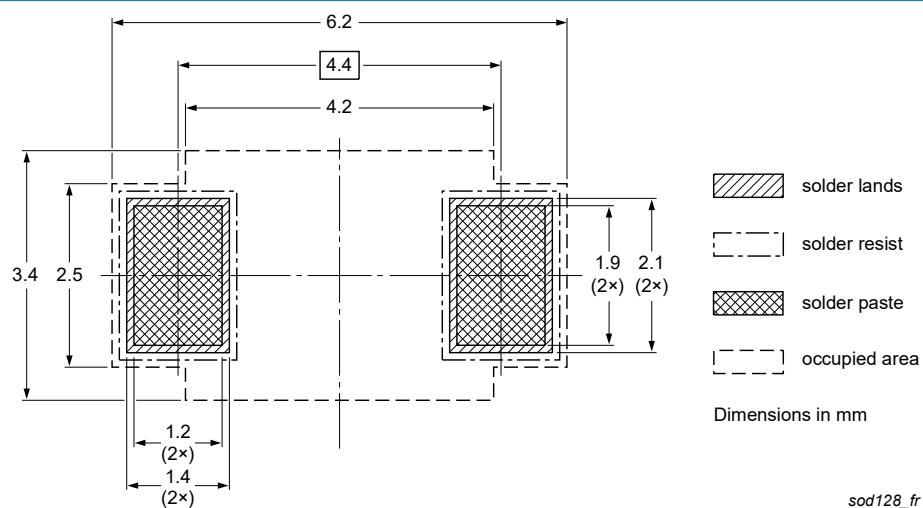
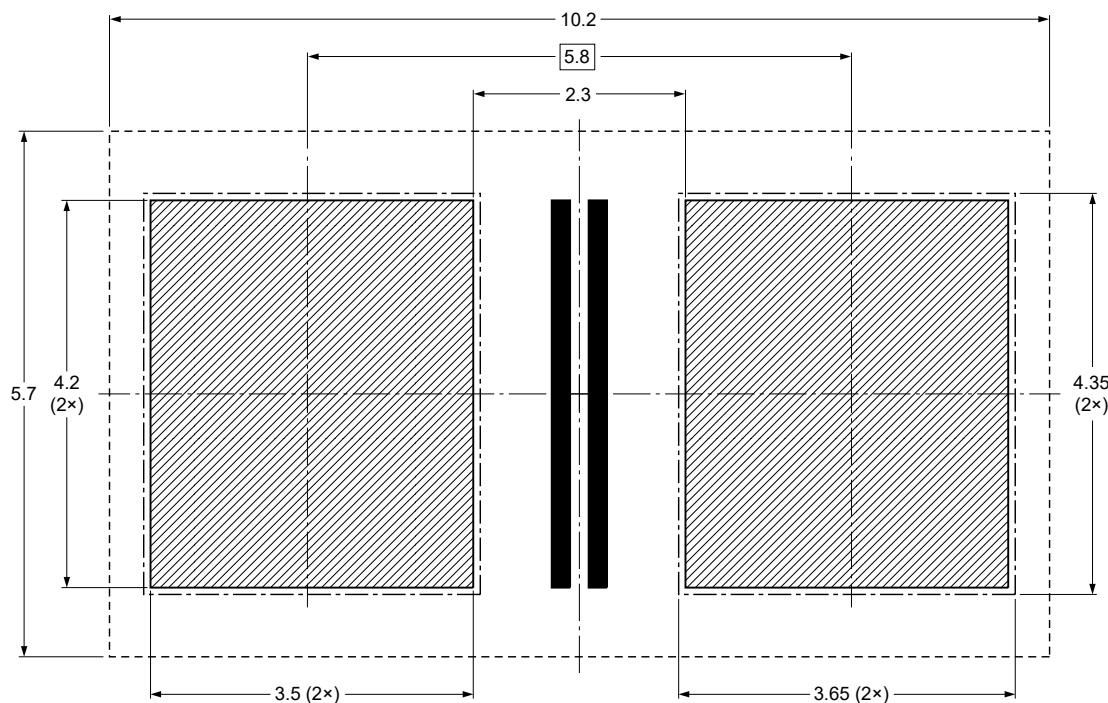


Fig. 16. Reflow soldering footprint for CFP5 (SOD128)

## Wave soldering footprint information

SOD128



[dashed box] occupied area

[solid box] solder resist

[hatched box] solder lands

[solid black box] dummy track (solder resist and Cu free)

Dimensions in mm

Issue date 17-06-06  
17-06-07

sod128\_fw

Fig. 17. Wave soldering footprint for CFP5 (SOD128)

## 14. Revision history

**Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PNE20030EP v.5	20240110	Product data sheet	-	PNE20030EP v.4
Modifications:	<ul style="list-style-type: none"><li>Product(s) changed to non-automotive qualification. Please refer to <a href="http://nexperia.com">nexperia.com</a> for automotive (-Q) product alternative(s).</li></ul>			
PNE20030EP v.4	20191218	Product data sheet	-	PNE20030EP v.3
PNE20030EP v.3	20191125	Preliminary data sheet	-	PNE20030EP v.2
PNE20030EP v.2	20191120	Product data sheet	-	PNE20030EP v.1
PNE20030EP v.1	20190227	Objective data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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